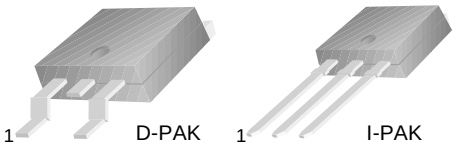
FAIRCHILD
SEMICONDUCTOR®

MJD30/30C

General Purpose Amplifier
Low Speed Switching Applications

- Load Formed for Surface Mount Application (No Suffix)
- Straight Lead (I-PAK, "- I" Suffix)
- Electrically Similar to Popular TIP30 and TIP30C



1.Base 2.Collector 3.Emitter

PNP Epitaxial Silicon Transistor

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{CBO}	Collector-Base Voltage		
	: MJD30	- 40	V
	: MJD30C	- 100	V
V_{CEO}	Collector-Emitter Voltage		
	: MJD30	- 40	V
	: MJD30C	- 100	V
V_{EBO}	Emitter-Base Voltage	- 5	V
I_C	Collector Current (DC)	- 1	A
I_{CP}	Collector Current (Pulse)	- 3	A
I_B	Base Current	- 4	A
P_C	Collector Dissipation (T_C=25°C)	15	W
	Collector Dissipation (Ta=25°C)	1.56	W
T_J	Junction Temperature	150	°C
T_{STG}	Storage Temperature	- 65 ~ 150	°C

Electrical Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
V_{CEO}(sus)	*Collector-Emitter Sustaining Voltage				
	: MJD30	I_C = - 30mA, I_B = 0	- 40		V
	: MJD30C		- 100		V
I_{CEO}	Collector Cut-off Current				
	: MJD30	V_{CE} = - 40V, I_B = 0		- 50	µA
	: MJD30C	V_{CE} = - 60V, I_B = 0		- 50	µA
I_{CES}	Collector Cut-off Current				
	: MJD30	V_{CE} = - 40V, V_{BE} = 0		- 20	µA
	: MJD30C	V_{CE} = 100V, V_{BE} = 0		- 20	µA
I_{EBO}	Emitter Cut-off Current	V_{BE} = - 5V, I_C = 0		- 1	mA
h_{FE}	* DC Current Gain	V_{CE} = - 4V, I_C = - 0.2A	40		
		V_{CE} = - 4V, I_C = - 1A	15	75	
V_{CE}(sat)	* Collector-Emitter Saturation Voltage	I_C = - 1A, I_B = - 125mA		- 0.7	V
V_{BE}(on)	* Base-Emitter ON Voltage	V_{CE} = - 4A, I_C = - 1A		- 1.3	V
f_T	Current Gain Bandwidth Product	V_{CE} = - 10V, I_C = - 200mA	3		MHz

* Pulse Test: PW≤300ms, Duty Cycle≤2%

Typical Characteristics

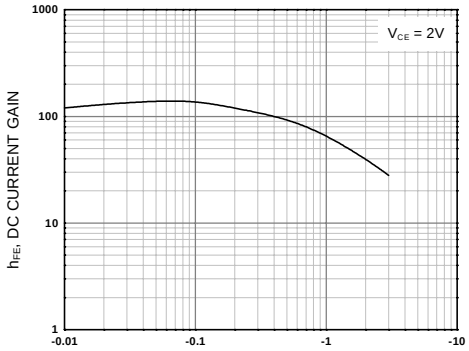


Figure 1. DC current Gain

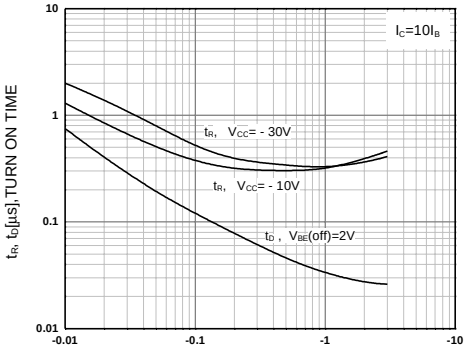


Figure 2. Turn On Time

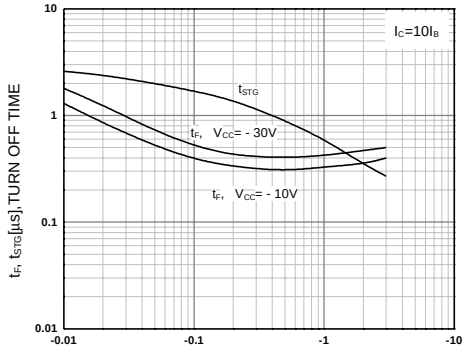


Figure 3. Turn Off Time

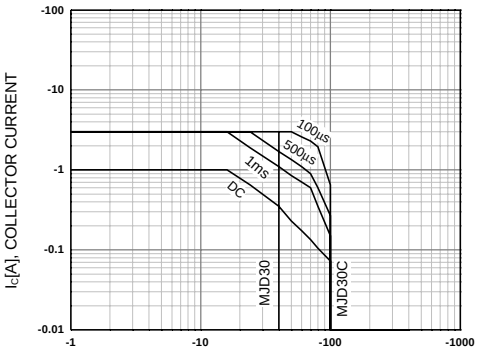


Figure 4. Safe Operating Area

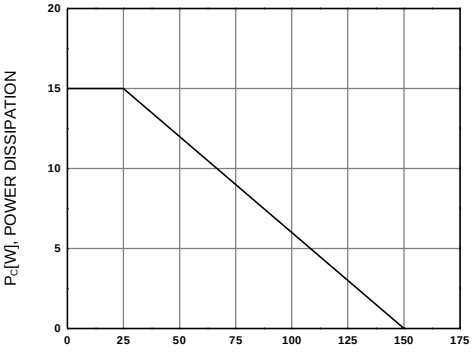
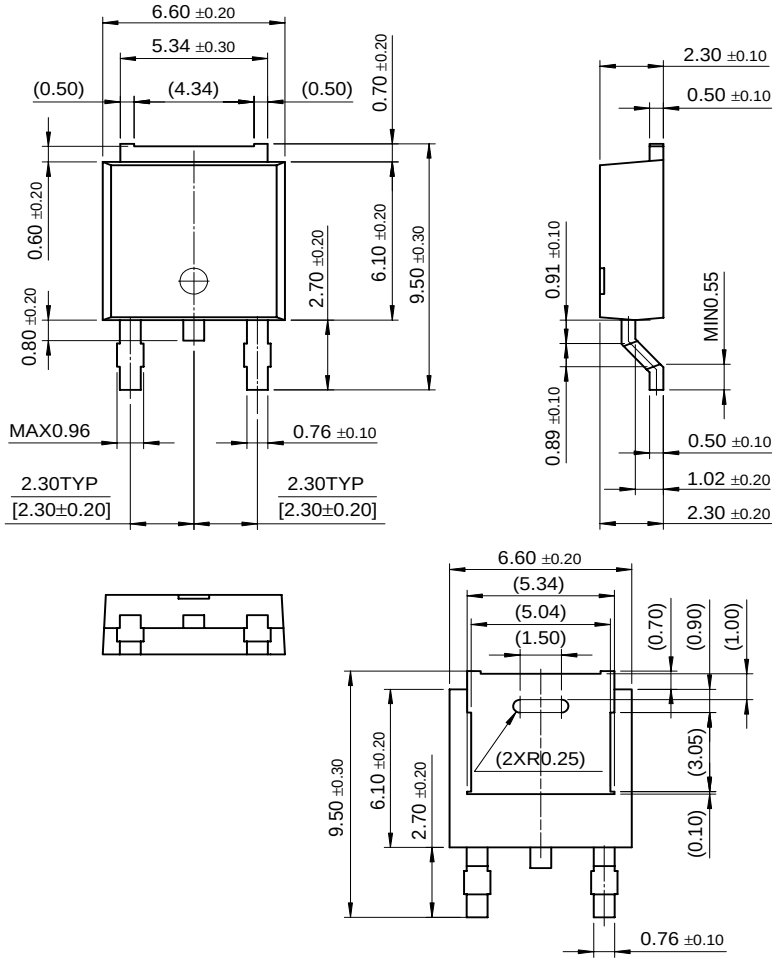


Figure 5. Power Derating

Package Demensions

D-PAK



Dimensions in Millimeters

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